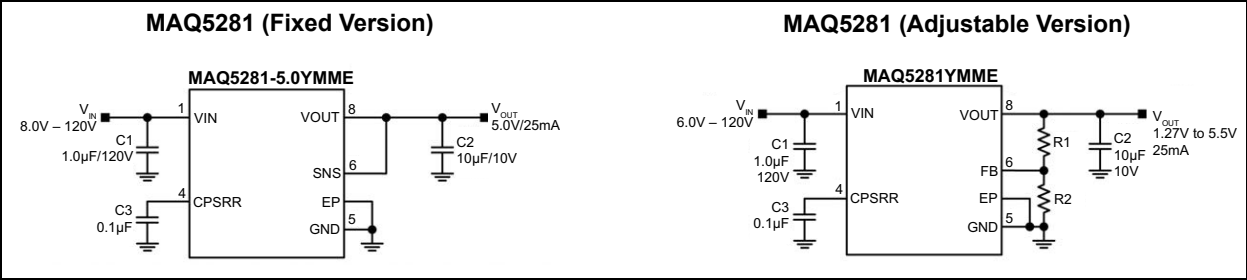


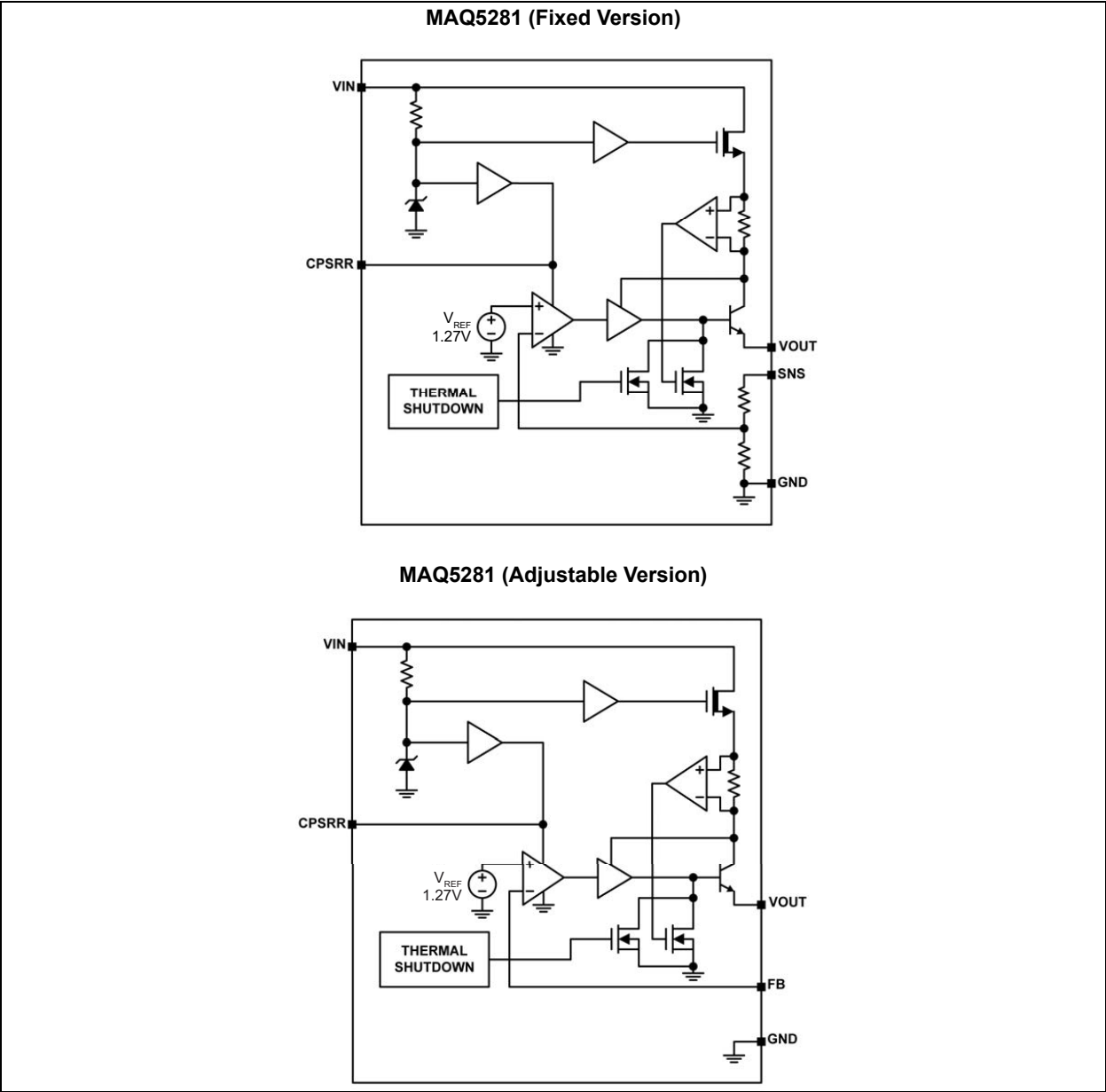


# MAQ5281

## Typical Application Circuits



## Functional Block Diagrams



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

$V_{IN}$ to GND .....	–0.3V to +125V
$V_{CPSRR}$ to GND .....	–0.3V to +14V
$V_{FB}$ , $V_{SNS}$ , $V_{OUT}$ to GND .....	–0.3V to +6V
Power Dissipation ( $P_D$ , <a href="#">Note 1</a> ) .....	Internally Limited
ESD Ratings ( <a href="#">Note 2</a> )	
HBM .....	2 kV
MM .....	200V

### Operating Ratings ‡

$V_{IN}$ .....	+6V to +120V
$V_{OUT}$ Adjust Range .....	+1.27V to +5.5V

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡ **Notice:** The device is not guaranteed to function outside its operating ratings.

**Note 1:** The maximum allowable power dissipation at any  $T_A$  (ambient temperature) is  $P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$ . Exceeding the maximum allowable power dissipation results in excessive die temperature, and causes the regulator to enter thermal shutdown.

**2:** Devices are ESD sensitive; use proper handling precautions. Human body model, 1.5 k $\Omega$  in series with 100 pF.

## ELECTRICAL CHARACTERISTICS

**Electrical Characteristics:**  $V_{IN} = 12V$ ,  $C_{IN} = 1.0 \mu F$ ,  $C_{PSRR} = 0.1 \mu F$ ,  $C_{OUT} = 10 \mu F$ ,  $I_{OUT} = 100 \mu A$ ,  $T_A = +25^\circ C$ , **bold** values valid for  $-40^\circ C \leq T_J \leq +125^\circ C$ , unless noted. ([Note 1](#))

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>Power Supply Input</b>						
Input Voltage Range	$V_{IN}$	6	—	120	V	<a href="#">Note 2</a>
Quiescent Supply Current	$I_Q$	—	6	<b>11</b>	$\mu A$	$I_{OUT} = 0$ , <a href="#">Note 3</a>
<b>Output Voltage</b>						
Output Voltage	$V_{OUT}$	1.27	—	5.5	V	Adjustable version
		3.2	3.3	3.4		Fixed 3.3V version
		<b>3.13</b>	3.3	<b>3.47</b>		
		4.85	5.0	5.15		Fixed 5.0 version
		<b>4.75</b>	5.0	<b>5.25</b>		
Output Voltage Accuracy	—	–3	—	+3	%	Variation from nominal $V_{OUT}$
		<b>–5</b>	—	<b>+5</b>		
Load Regulation	$\Delta V_{OUT}/V_{OUT}$	<b>–1.0</b>	0.2	<b>+1.0</b>	%	$I_{OUT} = 100 \mu A$ to 25 mA
Line Regulation	$\Delta V_{OUT}/(V_{OUT} \times \Delta V_{IN})$	<b>–0.5</b>	0.04	<b>+0.5</b>	%/V	$V_{IN} = 10V$ to 120V, <a href="#">Note 4</a>
<b>Feedback Input (Adjustable Version)</b>						
Feedback Voltage	$V_{FB}$	1.232	1.270	1.308	V	—
		<b>1.206</b>	1.270	<b>1.333</b>		
Feedback Current	$I_{FB}$	—	3.2	—	nA	$V_{FB} = 1.27V$

# MAQ5281

## ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Characteristics:**  $V_{IN} = 12V$ ,  $C_{IN} = 1.0 \mu F$ ,  $C_{PSRR} = 0.1 \mu F$ ,  $C_{OUT} = 10 \mu F$ ,  $I_{OUT} = 100 \mu A$ ,  $T_A = +25^\circ C$ , **bold** values valid for  $-40^\circ C \leq T_J \leq +125^\circ C$ , unless noted. ([Note 1](#))

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>Current Limit</b>						
Current Limit	$I_{LIM}$	<b>30</b>	65	<b>130</b>	mA	$V_{OUT} = 0V$
<b>Ripple Rejection</b>						
Power Supply Rejection Ratio	PSRR	—	90	—	dB	$f = 20 \text{ kHz to } 2 \text{ MHz}$
<b>Power Dropout Voltage</b>						
Dropout Voltage	$V_{DO}$	—	2	<b>3</b>	V	$I_{OUT} = 25 \text{ mA}$
<b>Thermal Protection</b>						
Thermal Shutdown Temperature	$T_{SHDN}$	—	157	—	$^\circ C$	$T_J$ rising
Thermal Shutdown Hysteresis	$T_{SD \text{ HYS}}$	—	15	—	$^\circ C$	—

**Note 1:** Specifications are for packaged products only.

2: Ensure that  $V_{IN} \geq (V_{OUT} + 3V)$  and  $V_{IN} \geq 6V$ .

3: Quiescent current is specified for the adjustable option. The fixed options will add approximately  $1 \mu A$  due to the internal feedback resistors.

4: Line regulation is a percentage of  $V_{OUT}$ .

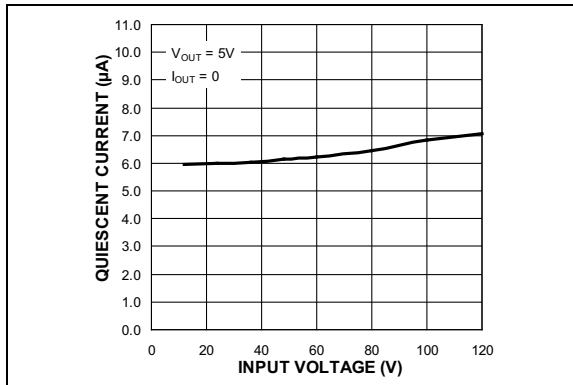
## TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Typ.	Max.	Units	Conditions
<b>Temperature Ranges</b>						
Junction Temperature Range	$T_J$	-40	—	+125	$^\circ C$	<a href="#">Note 1</a>
Storage Temperature Range	$T_S$	-65	—	+150	$^\circ C$	—
Lead Temperature	—	—	—	+260	$^\circ C$	Soldering, 10s
<b>Package Thermal Resistances</b>						
Thermal Resistance, MSOP 8-LD	$\theta_{JA}$	—	64	—	$^\circ C/W$	—

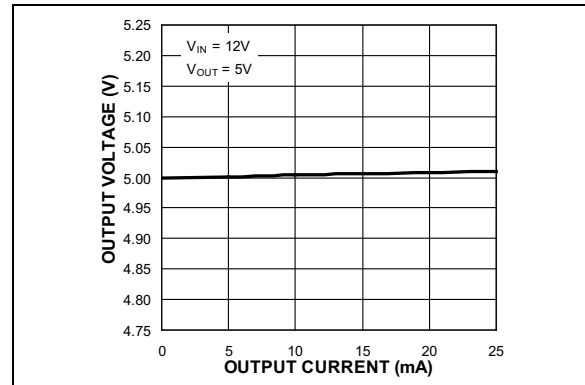
**Note 1:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e.,  $T_A$ ,  $T_J$ ,  $\theta_{JA}$ ). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum  $+125^\circ C$  rating. Sustained junction temperatures above  $+125^\circ C$  can impact the device reliability.

## 2.0 TYPICAL PERFORMANCE CURVES

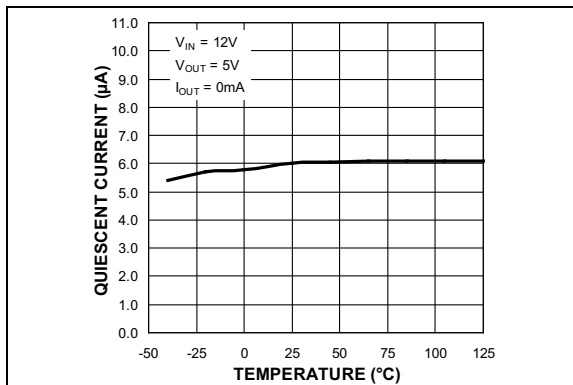
**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



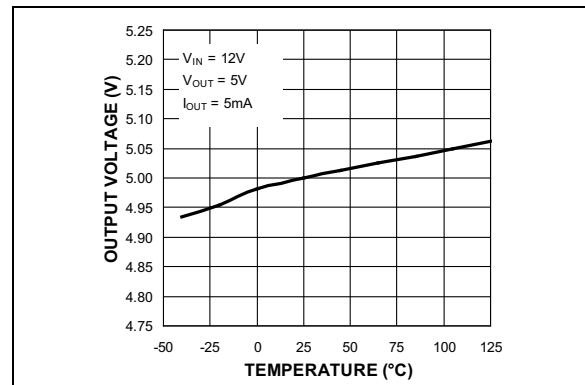
**FIGURE 2-1:** Quiescent Supply Current vs. Input Voltage.



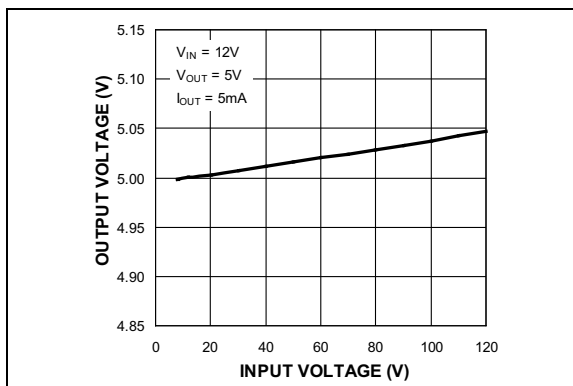
**FIGURE 2-4:** Output Voltage vs. Output Current.



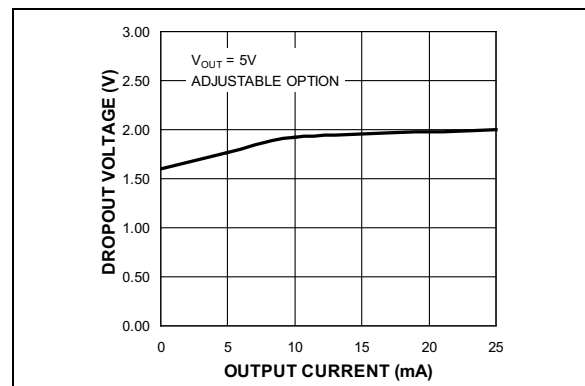
**FIGURE 2-2:** Quiescent Supply Current vs. Temperature.



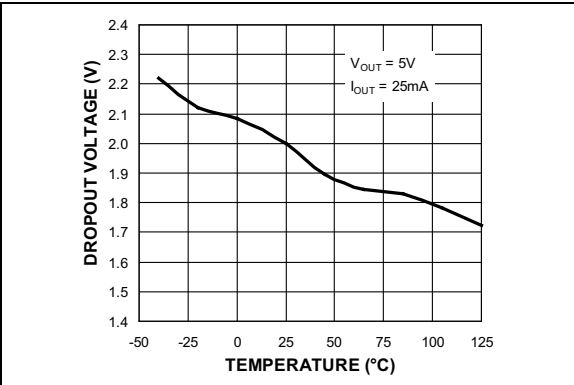
**FIGURE 2-5:** Output Voltage vs. Temperature.



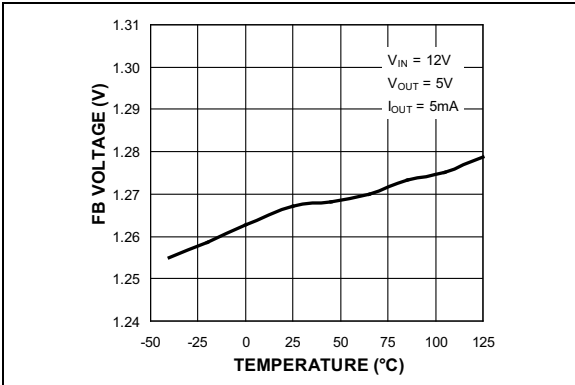
**FIGURE 2-3:** Output Voltage vs. Input Voltage.



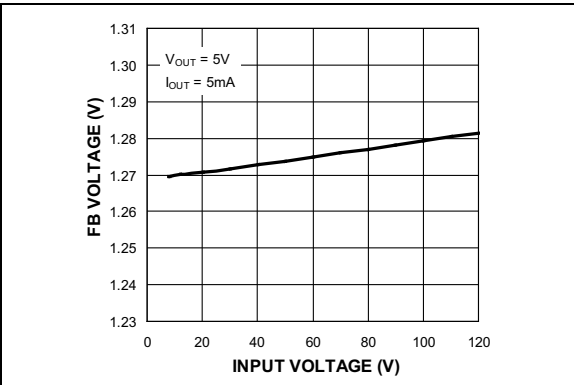
**FIGURE 2-6:** Dropout Voltage vs. Output Current.



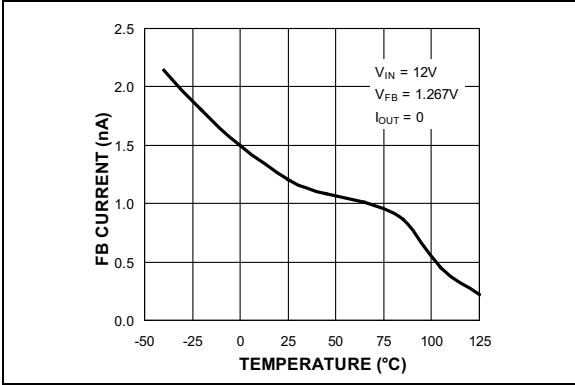
**FIGURE 2-7:** *Dropout Voltage vs. Temperature.*



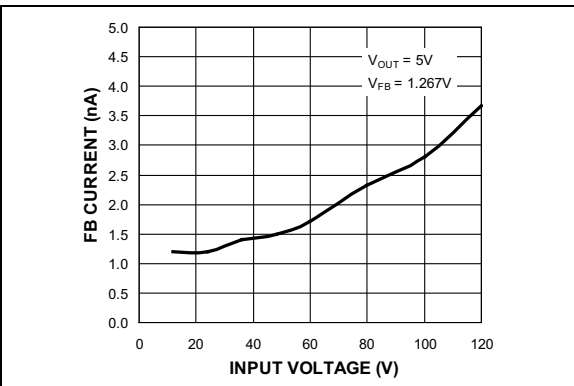
**FIGURE 2-10:** *Feedback Pin Voltage vs. Temperature.*



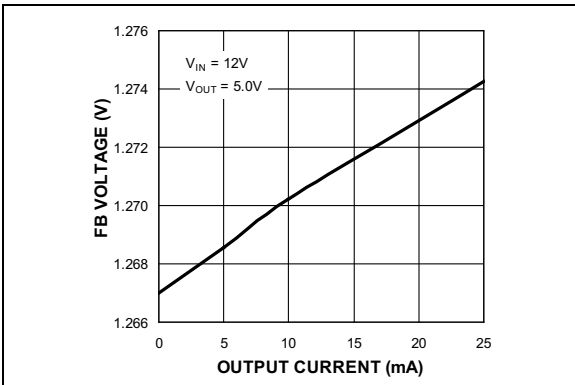
**FIGURE 2-8:** *Feedback Pin Voltage vs. Input Voltage.*



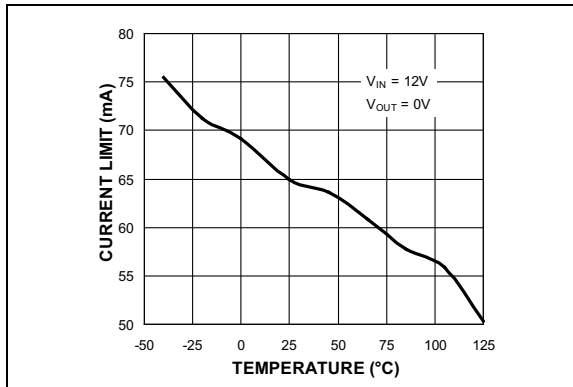
**FIGURE 2-11:** *Feedback Pin Current vs. Temperature.*



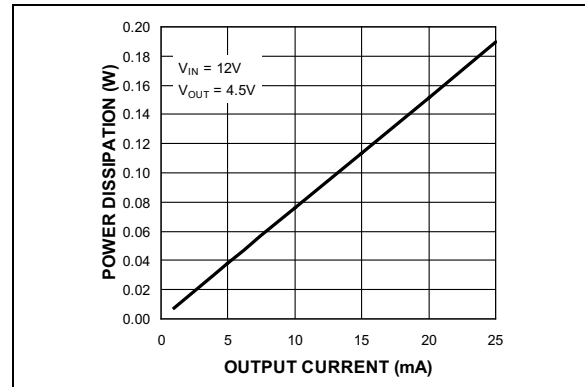
**FIGURE 2-9:** *Feedback Pin Current vs. Input Voltage.*



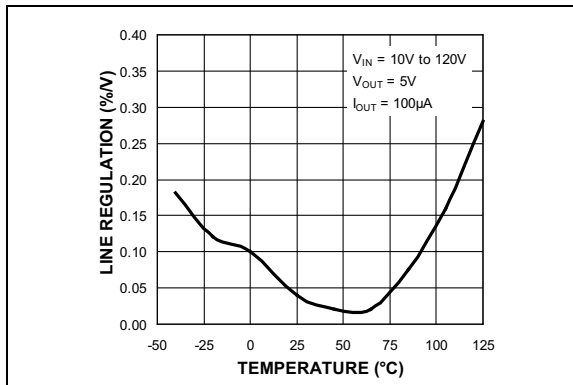
**FIGURE 2-12:** *Feedback Pin Voltage vs. Output Current.*



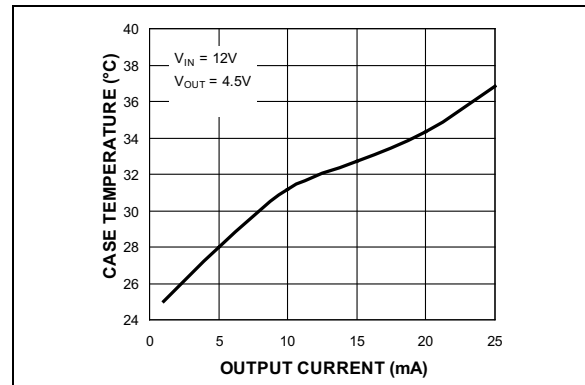
**FIGURE 2-13:** Current Limit vs. Temperature.



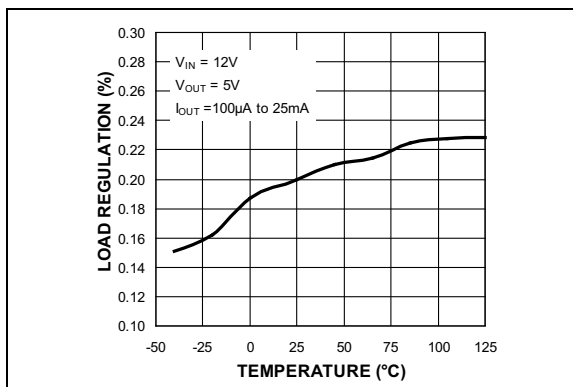
**FIGURE 2-16:** Power Dissipation vs. Output Current.



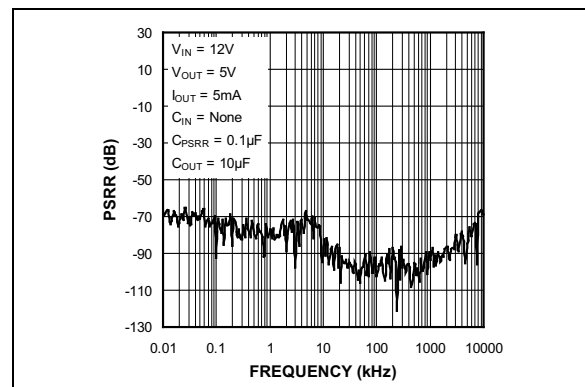
**FIGURE 2-14:** Line Regulation vs. Temperature.



**FIGURE 2-17:** Case Temperature\* vs. Output Current.

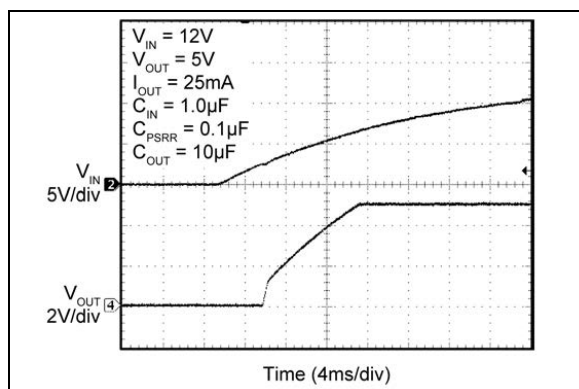


**FIGURE 2-15:** Load Regulation vs. Temperature.

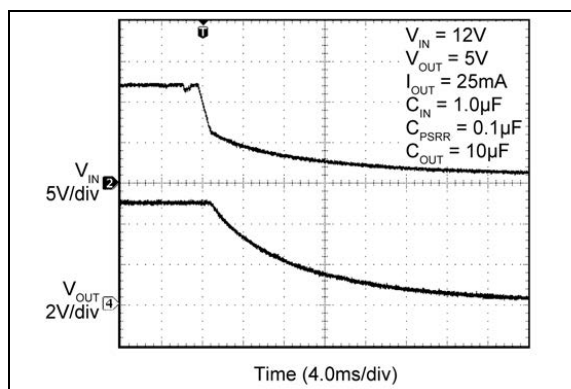


**FIGURE 2-18:** PSRR vs. Frequency.

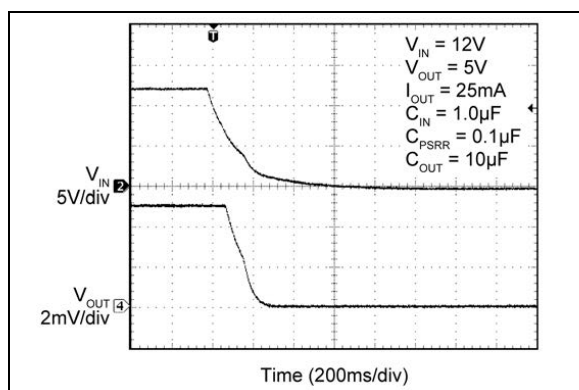
\* The temperature measurement was taken at the hottest point on the MAQ5282 case mounted on a 2.25 square inch PCB at an ambient temperature of +25°C; see the "Thermal Measurement" section. Actual results will depend upon the size of the PCB, ambient temperature, and proximity to other heat emitting components.



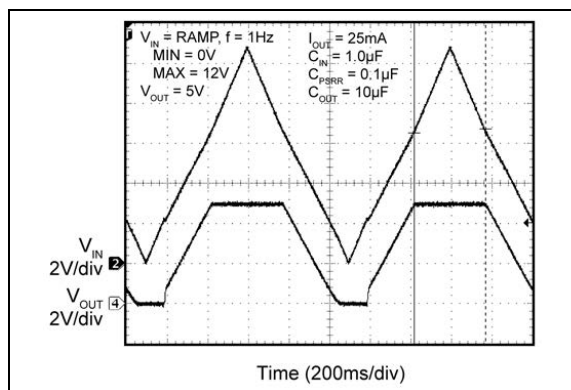
**FIGURE 2-19:** Soft Turn-On into Full Load.



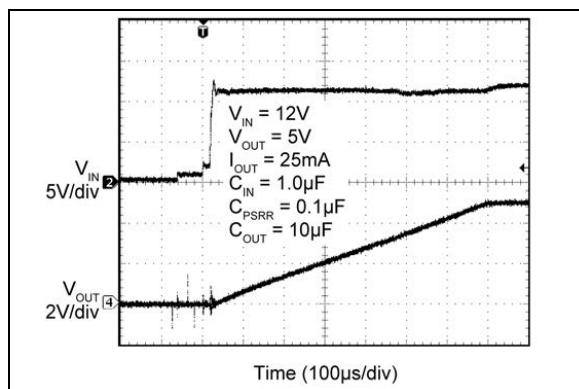
**FIGURE 2-22:** Hot Un-Plug.



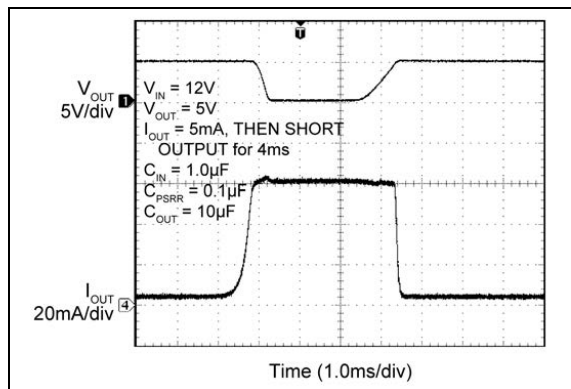
**FIGURE 2-20:** Soft Turn-Off.



**FIGURE 2-23:** Turn-On and Turn-Off.

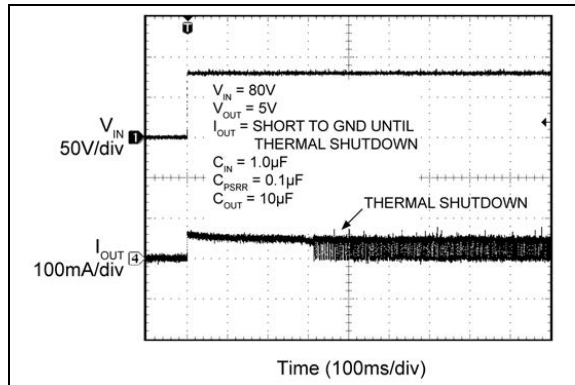


**FIGURE 2-21:** Hot Plug.

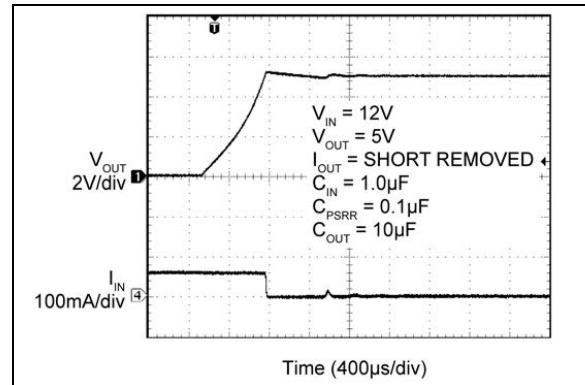


**FIGURE 2-24:** Current Limit.

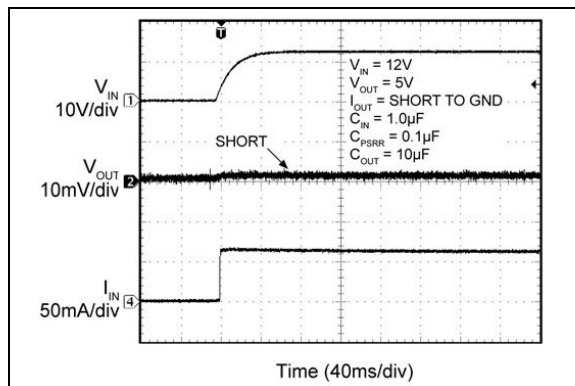




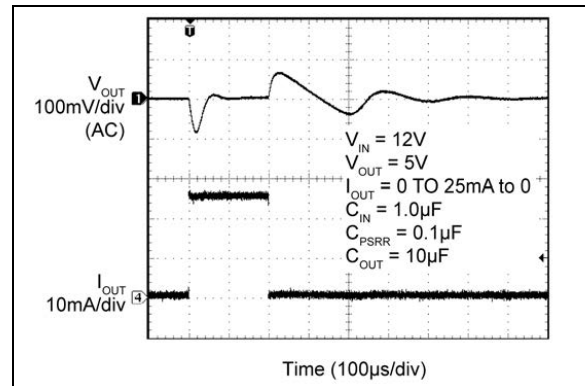
**FIGURE 2-25:** Thermal Shutdown, Short Circuit.



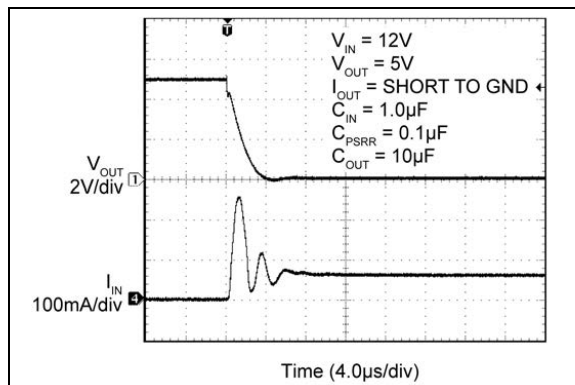
**FIGURE 2-28:** Short-Circuit Output Voltage Recovery.



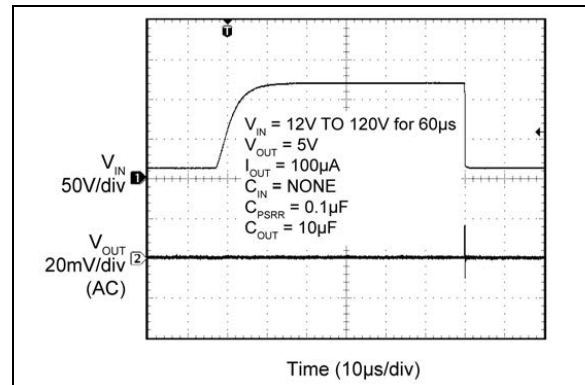
**FIGURE 2-26:** Turn-On into Short Circuit.



**FIGURE 2-29:** Load Transient Response.



**FIGURE 2-27:** Short-Circuit Response.



**FIGURE 2-30:** Line Transient Response.

## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

**TABLE 3-1: PIN FUNCTION TABLE**

Pin Number (Adj. Version)	Pin Number (Fixed Version)	Pin Name	Description
1	1	VIN	Supply Voltage Input. Connect 1 $\mu$ F capacitor from VIN to GND.
2, 3, 7	2, 3, 7	NC	Not internally connected. Connect NC to GND or leave unconnected.
4	4	CPSRR	Bypass Capacitor Connection. Connect 0.1 $\mu$ F capacitor from CPSRR to GND.
5	5	GND	Ground.
6	—	FB	Feedback Connection. For external resistor divider to set $V_{OUT}$ .
—	6	SNS	Sense input. Connect SNS to VOUT.
8	8	VOUT	Regulator Output. Connect 10 $\mu$ F capacitor from VOUT to GND.
EP	EP	ePAD	Exposed Pad for Thermal Relief. Connect EP to GND.

## 4.0 DETAILED DESCRIPTION

The MAQ5281 voltage regulator accepts a 6V to 120V input and has an ultra-low 6  $\mu$ A typical quiescent current while offering an excellent line transient response and PSRR. These features make it ideal for harsh, noisy environments. All options of the device offer 25 mA of output current. The MAQ5281YMME offers an adjustable output voltage from 1.27V to 5.5V. The MAQ5281-3.3YMME offers fixed 3.3V outputs and the MAQ5281-5.0YMME offers fixed 5.0V outputs. The MME packaged devices feature a heat slug to more effectively remove heat from the die.

## 5.0 APPLICATIONS INFORMATION

### 5.1 Thermal Protection

The MAQ5281 has an internal thermal shutdown circuit to protect it from excessive heating of the die. When the junction temperature exceeds approximately +155°C, the output is disabled and the device begins to cool down. The device turns back on when the junction temperature cools by 15°C. This will result in a cycled output during continuous thermal-overload conditions.

### 5.2 Current Limit

The MAQ5281 features output current-limit protection. The output sustains a continuous short circuit to GND without damage to the device, but thermal shutdown often results.

### 5.3 Input Capacitor

Connect a 1  $\mu$ F capacitor from VIN to GND. Microchip recommends the C5750X7R2E105M, 1  $\mu$ F, 250V capacitor made by TDK. When using a different capacitor, ensure that the voltage rating of the capacitor exceeds any potential transient.

### 5.4 CPSRR Capacitor

Connect a 0.1  $\mu$ F capacitor from CPSRR to GND to maintain high power supply rejection. The voltage rating of the capacitor must be at least 14V.

### 5.5 Output Capacitor

Connect a 10  $\mu$ F capacitor from VOUT to GND. Ensure that the voltage rating of the capacitor exceeds the designed output voltage of the MAQ5281.

### 5.6 Output Voltage Setting

For the MAQ5281YMME,  $V_{OUT}$  is programmed from 1.27V to 5.5V using:

#### EQUATION 5-1:

$$V_{OUT} = V_{REF} \times \left( \frac{R1}{R2} + 1 \right)$$

Where:

$V_{REF} = 1.27V$

R1 and R2 are shown in the Typical Application Circuits.

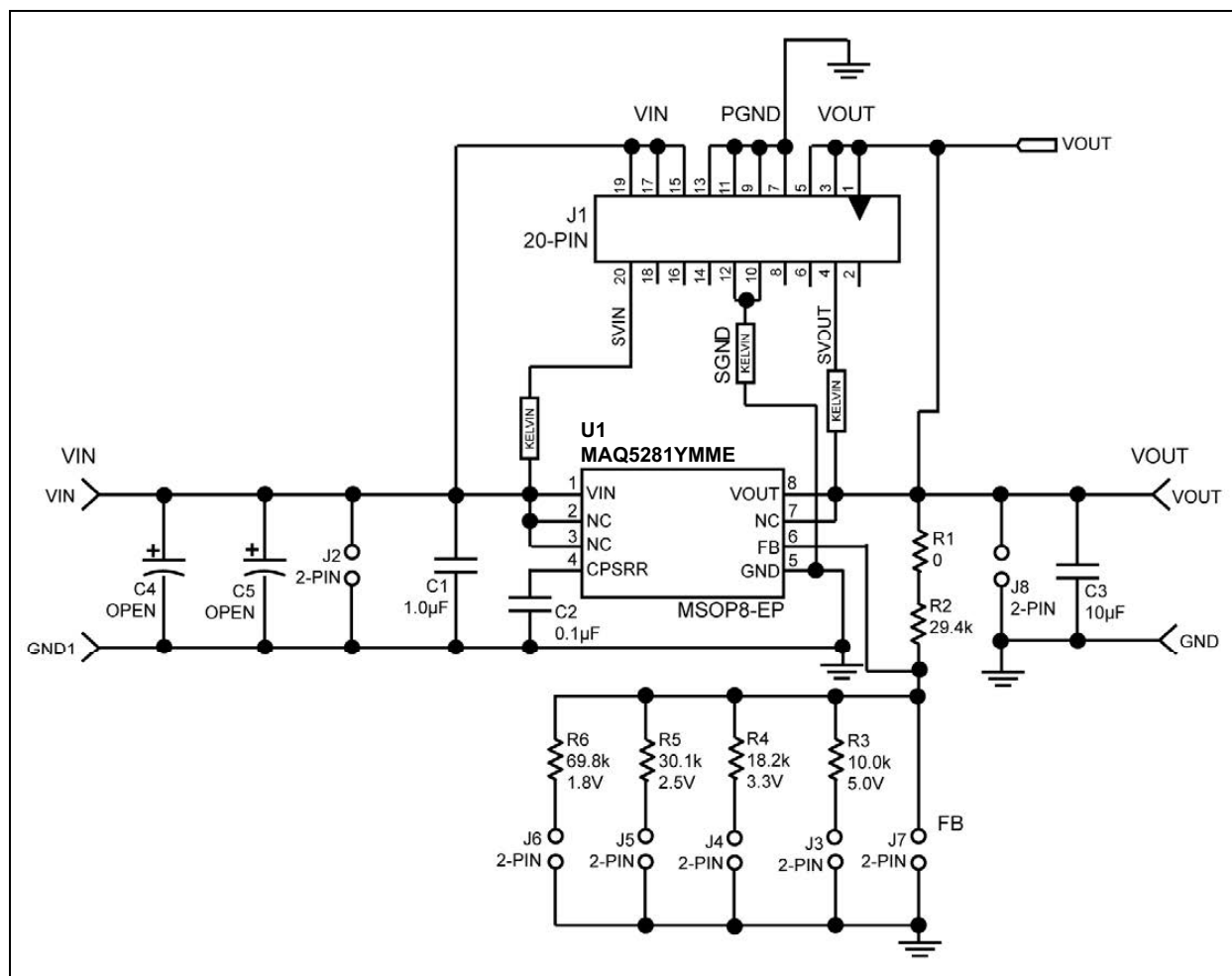
### 5.7 Thermal Measurements

It is always wise to measure an IC's case temperature to make sure that it is within operating limits, but it is easy to get erroneous results. The standard thermocouple that comes with many voltage meters uses a large wire gauge that behaves like a heat-sink, resulting in artificially low case temperature measurements. Use a thermocouple of 36-gauge wire or smaller, such as the Omega (5SC-TT-K-36-36), to minimize the heat-sinking effect. Also, apply thermal compound to maximize heat transfer between the IC and the thermocouple.

An infrared thermometer is a recommended alternative. The IR thermometer from Optris has a 1 mm spot size, ideal for monitoring small surface mount packages. Also, the optional stand makes it easy to keep the beam on the IC for long periods of time.

# MAQ5281

## 6.0 EVALUATION BOARD SCHEMATIC

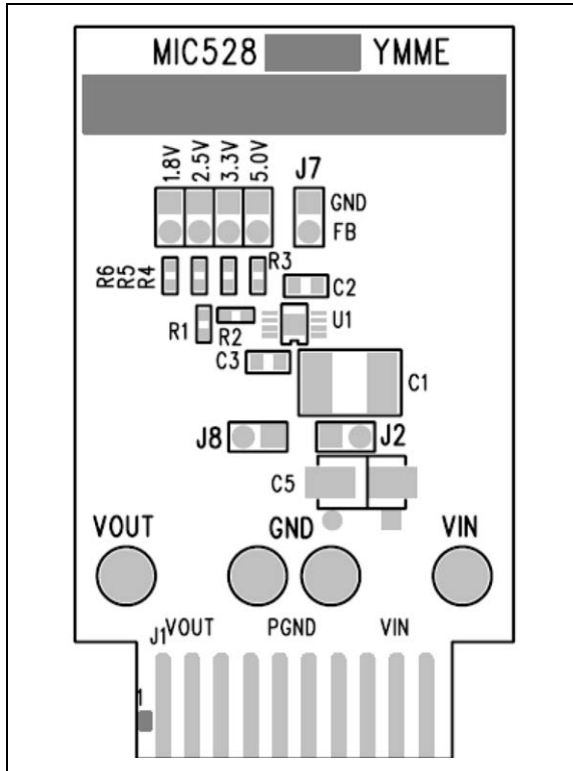


**FIGURE 6-1:** MAQ5281 Evaluation Board Schematic.

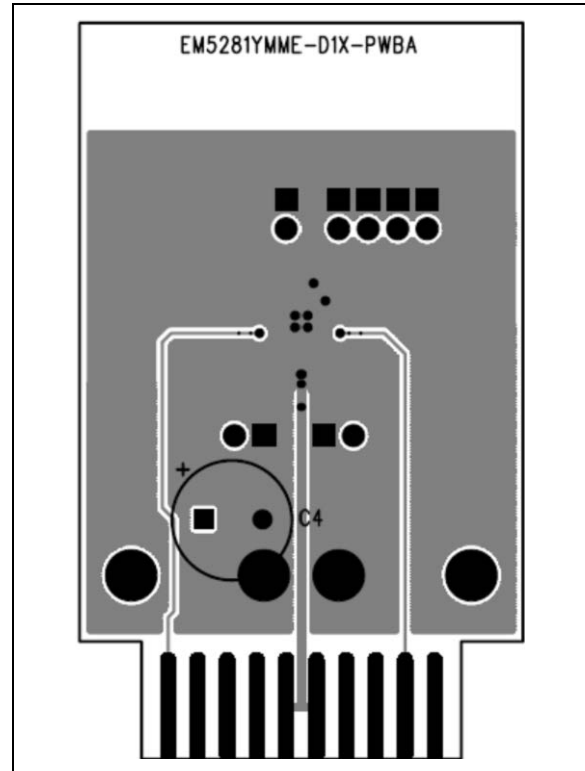
**TABLE 6-1: BILL OF MATERIALS**

Item	Part Number	Manufacturer	Description	Qty.
C1	C5750X7R2E105M	TDK	1.0 µF, 250V, 20%, X7R capacitor (2220)	1
C2	08053C104KAT2A	AVX	0.1 µF 25V 20%, X7R capacitor (0805)	1
C3	0805ZD106KAT2A	AVX	10 µF, 10V, 20%, X5R, capacitor (0805)	1
C4, C5	OPEN	—	—	0
R1	CRCW06030000F	Vishay/Dale	0Ω, 1% resistor, 0603	1
R2	CRCW06032942F	Vishay/Dale	29.4 kΩ, 1% resistor, 0603	1
R3	CRCW06031002F	Vishay/Dale	10.0 kΩ, 1% resistor, 0603	1
R4	CRCW06031822F	Vishay/Dale	18.2 kΩ, 1%, resistor, 0603	1
R5	CRCW06033012F	Vishay/Dale	30.1 kΩ, 1% resistor chip, 0603	1
R6	CRCW06036982F	Vishay/Dale	69.8 kΩ, 1%, resistor, 0603	1
U1	MAQ5281YMME	Microchip	120V <sub>IN</sub> , 25 mA, Ultra-Low I <sub>Q</sub> , High-PSRR Linear Regulator	1

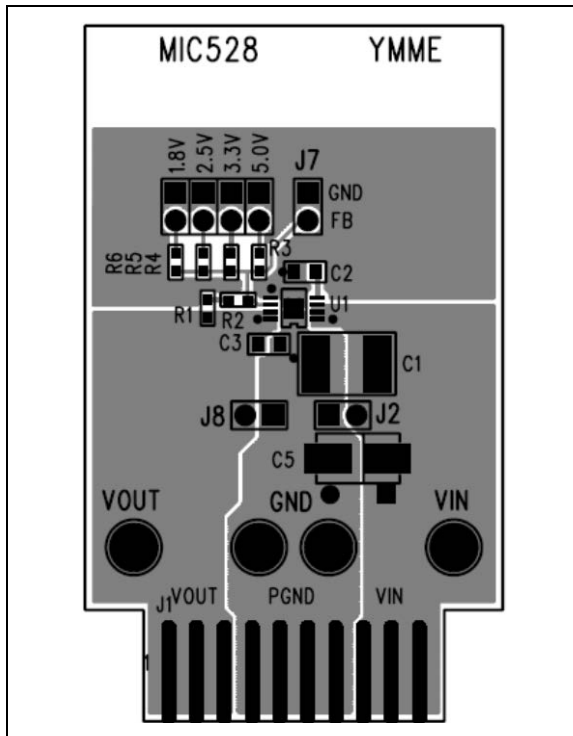
## 7.0 PCB EVALUATION BOARD LAYOUT



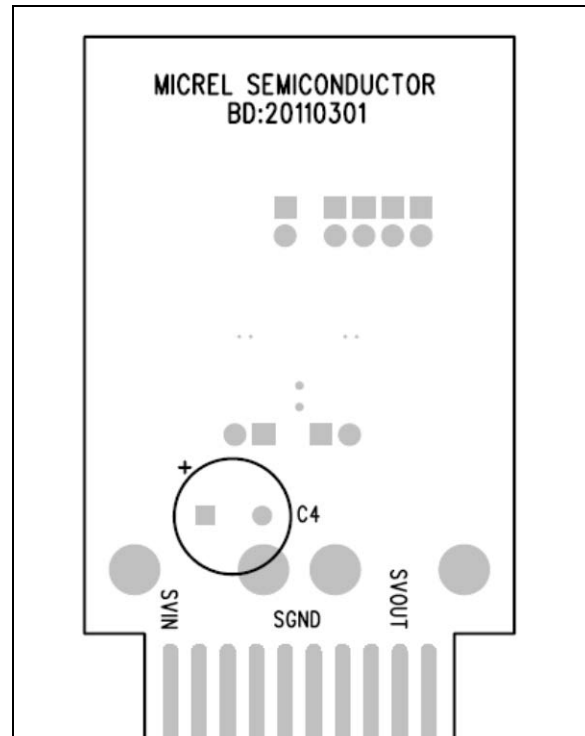
**FIGURE 7-1:** Top Layer Silk Screen.



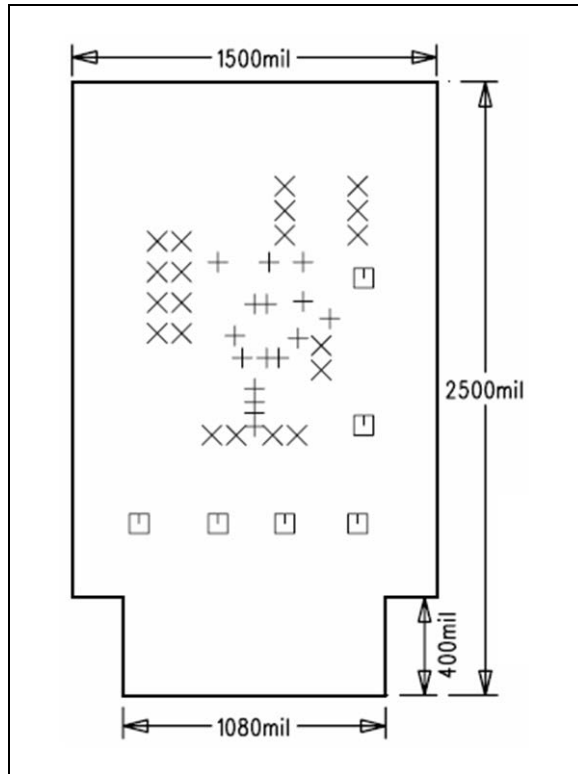
**FIGURE 7-3:** Bottom Layer Traces.



**FIGURE 7-2:** Top Layer Traces.



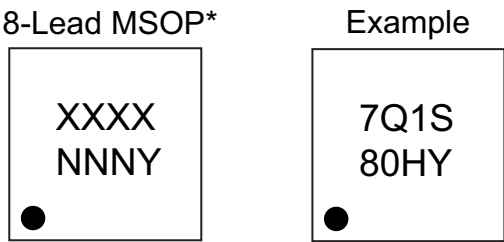
**FIGURE 7-4:** Bottom Layer Silk Screen.



**FIGURE 7-5:** EV Board Dimensions.

8.0 PACKAGING INFORMATION

8.1 Package Marking Information



<b>Legend:</b>	XX...X	Product code or customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
	•, ▲, ▼	Pin one index is identified by a dot, delta up, or delta down (triangle mark).
<b>Note:</b>	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.	
	Underbar ( _ ) symbol may not be to scale.	

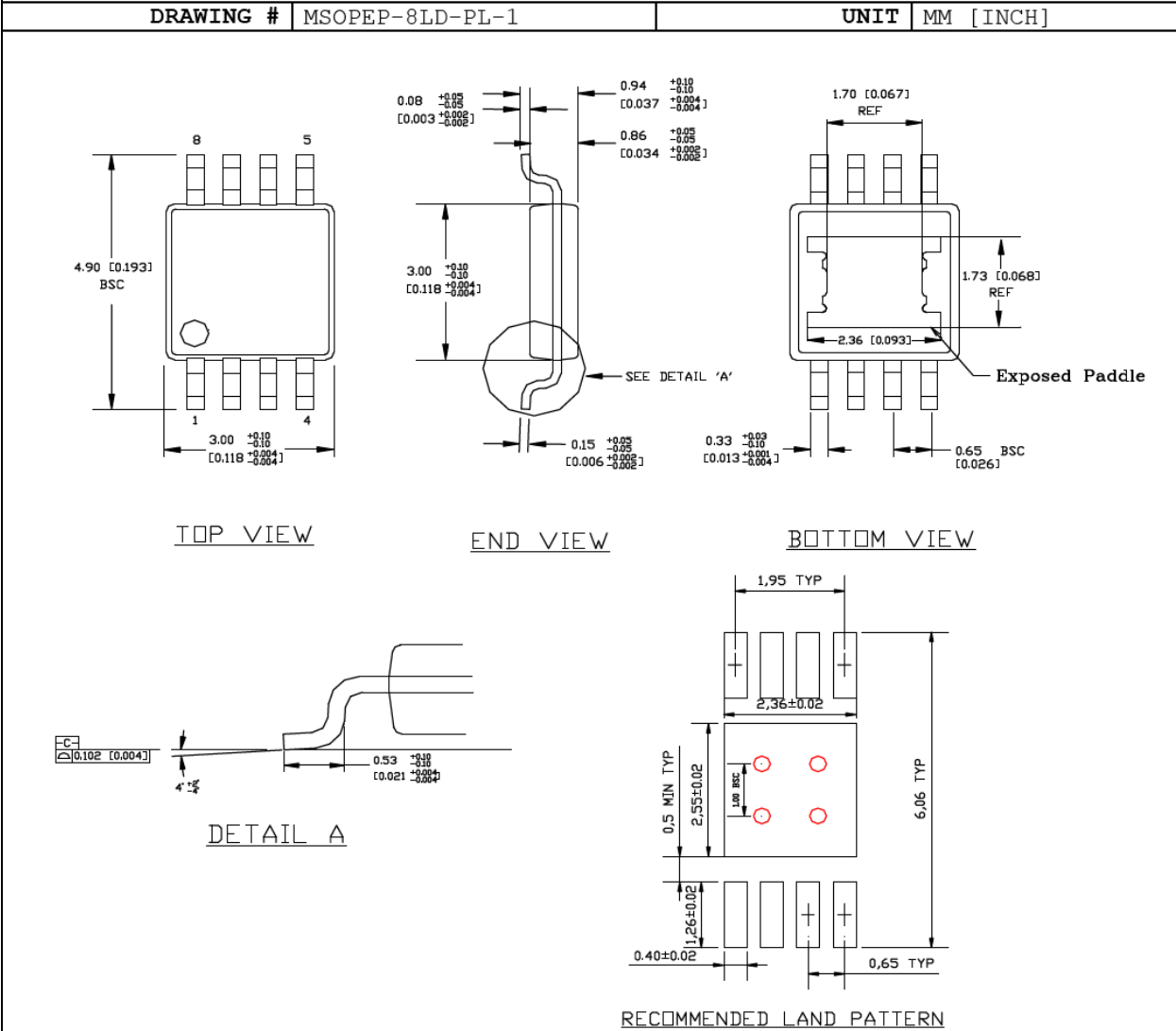
**Note:** If the full seven-character YYWWNNN code cannot fit on the package, the following truncated codes are used based on the available marking space:  
6 Characters = YWWNNN; 5 Characters = WWNNN; 4 Characters = WNNN; 3 Characters = NNN;  
2 Characters = NN; 1 Character = N

# MAQ5281

## 8-Lead MSOP ePAD Package Outline and Recommended Land Pattern

**TITLE**

8 LEAD MSOP EPAD PACKAGE OUTLINE & RECOMMENDED LAND PATTERN



NOTE:  
1. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.20 [0.008] PER SIDE  
2. RED CIRCLES IN LAND PATTERN REPRESENT THERMAL VIAS, RECOMMENDED SIZE IS 0.30-0.35MM IN DIAMETER, 1.00 PITCH AND SHOULD BE CONNECTED TO GND FOR MAXIMUM PERFORMANCE

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.



## APPENDIX A: REVISION HISTORY

### Revision A (October 2022)

- Converted Micrel document MAQ5281 to Microchip data sheet DS20006731A.
- Minor text changes throughout.

# MAQ5281

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NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

<u>Part Num- ber</u>	<u>-X.X</u>	<u>X</u>	<u>XX</u>	<u>-XX</u>	<u>VXX</u>
Device	Output Voltage	Temp. Range	Package	Media Type	Automotive Suffix
<b>Device:</b> MAQ5281: 120V <sub>IN</sub> , 25 mA, Ultra-Low I <sub>Q</sub> , High-PSRR Linear Regulator					
<b>Output Voltage:</b> <blank>= Adjustable 3.3 = 3.3V 5.0 = 5.0V					
<b>Temperature Range:</b> Y = -40°C to +125°C					
<b>Package:</b> MME= 8-Lead MSOP					
<b>Media Type:</b> TR = 2,500/Reel <blank>= 100/Tube					
<b>Automotive Suffix:</b> Vxx = Automotive suffix in which "xx" is assigned by Microchip. VAO is standard automotive option.					

**Examples:**  
  
 a) MAQ5281YMME-VAO: MAQ5281, Adj. Output Voltage, -40°C to +125°C Temp. Range, 8-Lead MSOP, 100/Tube, Automotive Option  
  
 b) MAQ5281-3.3YMME-TRVAO: MAQ5281, 3.3V Output Voltage, -40°C to +125°C Temp. Range, 8-Lead MSOP, 2500/Reel, Automotive Option  
  
 c) MAQ5281-5.0YMME-TRVAO: MAQ5281, 5.0V Output Voltage, -40°C to +125°C Temp. Range, 8-Lead MSOP, 2500/Reel, Automotive Option  
  
**Note 1:** Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

# MAQ5281

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NOTES:

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